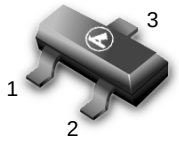
General Purpose Transistor

PNP Silicon

LMBT2907LT1G
LMBT2907ALT1G
S-LMBT2907LT1G
S-LMBT2907ALT1G

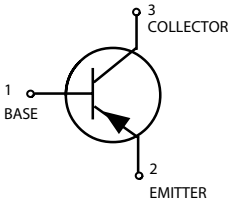
● We declare that the material of product compliance with RoHS requirements.



SOT–23

MAXIMUM RATINGS

Rating	Symbol	Value 2907	Value 2907A	Unit
Collector–Emitter Voltage	V_{CEO}	–40	–60	Vdc
Collector–Base Voltage	V_{CBO}		–60	Vdc
Emitter–Base Voltage	V_{EBO}		–5.0	Vdc
Collector Current — Continuous	I_C		–600	mAdc



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR– 5 Board, (1) T_A = 25°C	P_D	225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (2) T_A = 25°C	P_D	300	mW
Derate above 25°C		2.4	mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T_J , T_{stg}	–55 to +150	°C

ORDERING INFORMATION

Device	Marking	Shipping
LMBT2907LT1G S-LMBT2907LT1G	M2B	3000/Tape & Reel
LMBT2907LT3G S-LMBT2907LT3G	M2B	10000/Tape & Reel
LMBT2907ALT1G S-LMBT2907ALT1G	2F	3000/Tape & Reel
LMBT2907ALT3G S-LMBT2907ALT3G	2F	10000/Tape & Reel

DEVICE MARKING

LMBT2907LT1G = M2B, LMBT2907ALT1G = 2F

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage(3)		$V_{(BR)CEO}$			Vdc
(I_C = –10 mAdc, I_B = 0)	LMBT2907		–40	—	
	LMBT2907A		–60	—	
Collector–Emitter Breakdown Voltage(I_C = –10 µAdc, I_E = 0)		$V_{(BR)CBO}$	–60	—	Vdc
Emitter–Base Breakdown Voltage(I_E = –10 µAdc, I_C = 0)		$V_{(BR)EBO}$	–5.0	—	Vdc
Collector Cutoff Current(V_{CB} = –30Vdc, $I_{BE(OFF)}$ = –0.5Vdc)		I_{CEX}	—	–50	nAdc
Collector Cutoff Current		I_{CBO}			µAdc
(V_{CB} = –50Vdc, I_E = 0)	LMBT2907		—	–0.020	
	LMBT2907A		—	–0.010	
(V_{CB} = –50Vdc, I_E = 0, T_A =125°C)	LMBT2907		—	–20	
	LMBT2907A		—	–10	
Base Current(V_{CE} = –30Vdc, $V_{EB(off)}$ = –0.5Vdc)		I_B	—	–50	nAdc

1. FR–5 = 1.0 x 0.75 x 0.062 in.
2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.
3. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic		Symbol	Min	Max	Unit
ON CHARACTERISTICS					
DC Current Gain		h_{FE}			—
(I_C = –0.1mAdc, V_{CE} = –10 Vdc)	LMBT2907		35	—	
	LMBT2907A		75	—	
(I_C =–1.0mAdc, V_{CE} = –10 Vdc)	LMBT2907		50	—	
	LMBT2907A		100	—	
(I_C = –10 mAdc, V_{CE} = –10Vdc)	LMBT2907		75	—	
	LMBT2907A		100	—	
(I_C = –150mAdc, V_{CE} =–10 Vdc)(3)	LMBT2907		—	—	
	LMBT2907A		100	300	
(I_C = –500mAdc, V_{CE} =–10 Vdc)(3)	LMBT2907		30	—	
	LMBT2907A		50	—	
Collector–Emitter Saturation Voltage(3)		$V_{CE(sat)}$			Vdc
(I_C = –150mAdc, I_B = –15 mAdc)			—	–0.4	
(I_C = –500 mAdc, I_B = –50 mAdc)			—	–1.6	
Base–Emitter Saturation Voltage(3)		$V_{BE(sat)}$			Vdc
(I_C = –150mAdc, I_B = –15 mAdc)			—	–1.3	
(I_C = –500mAdc, I_B = –50 mAdc)			—	–2.6	
SMALL–SIGNAL CHARACTERISTICS					
Current–Gain — Bandwidth Product(3),(4) (I_C = –50mAdc, V_{CE}= –20Vdc, f = 100MHz)		f_T	200	—	MHz
Output Capacitance (V_{CB} = –10 Vdc, I_E = 0, f = 1.0 MHz)		C_{obo}	—	8.0	pF
Input Capacitance (V_{EB} = –2.0Vdc, I_C = 0, f = 1.0 MHz)		C_{ibo}	—	30	pF
SWITCHING CHARACTERISTICS					
Turn–On Time	(V_{CC} = –30 Vdc, I_C = –150 mAdc, I_{B1} = –15 mAdc)	t_{on}	—	45	ns
Delay Time		t_d	—	10	
Rise Time		t_r	—	40	
Fall Time	(V_{CC} = –6.0 Vdc, I_C = –150 mAdc,I_{B1} = I_{B2} = 15 mAdc)	t_f	—	30	ns
Storage Time		t_s	—	80	
Turn–Off Time		t_{off}	—	100	

3. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.
4. f_T is defined as the frequency at which $|h f_e|$ extrapolates to unity.

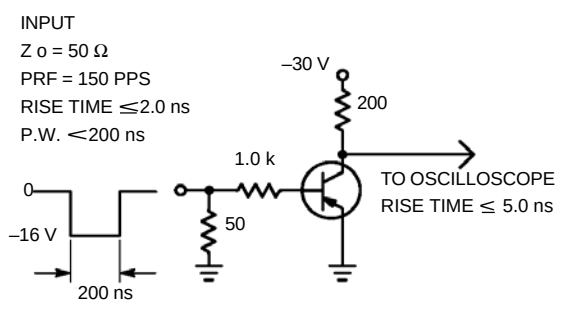


Figure 1. Delay and Rise Time Test Circuit

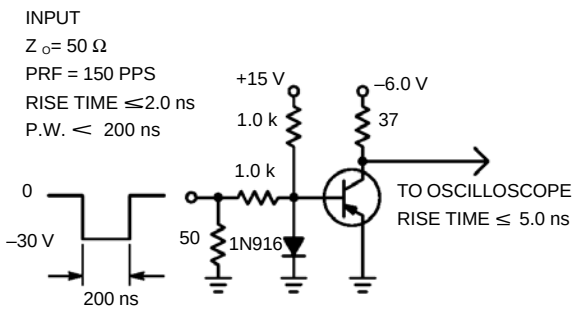


Figure 2. Storage and Fall Time Test Circuit

TYPICAL CHARACTERISTICS

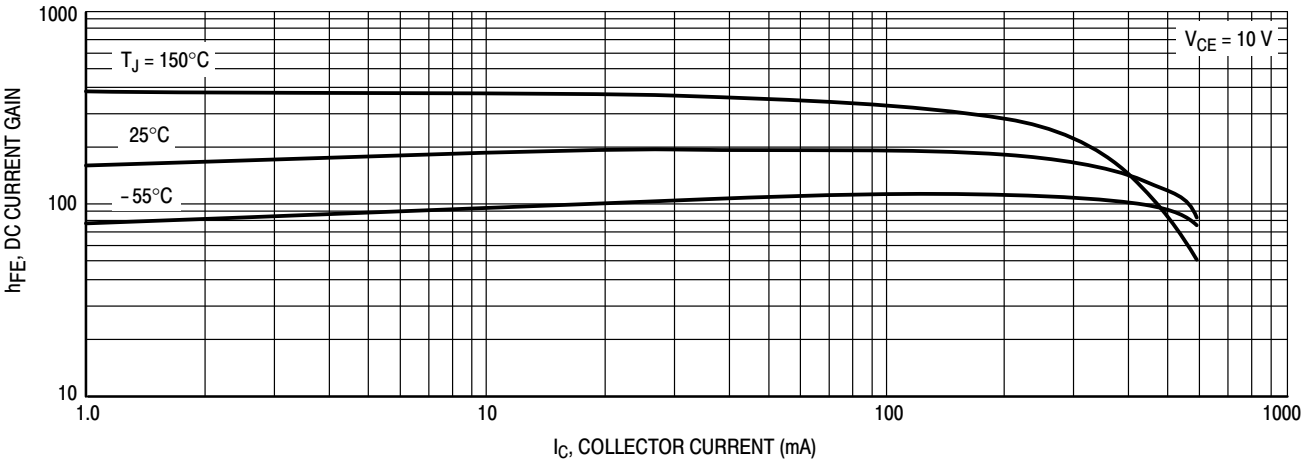


Figure 3. DC Current Gain

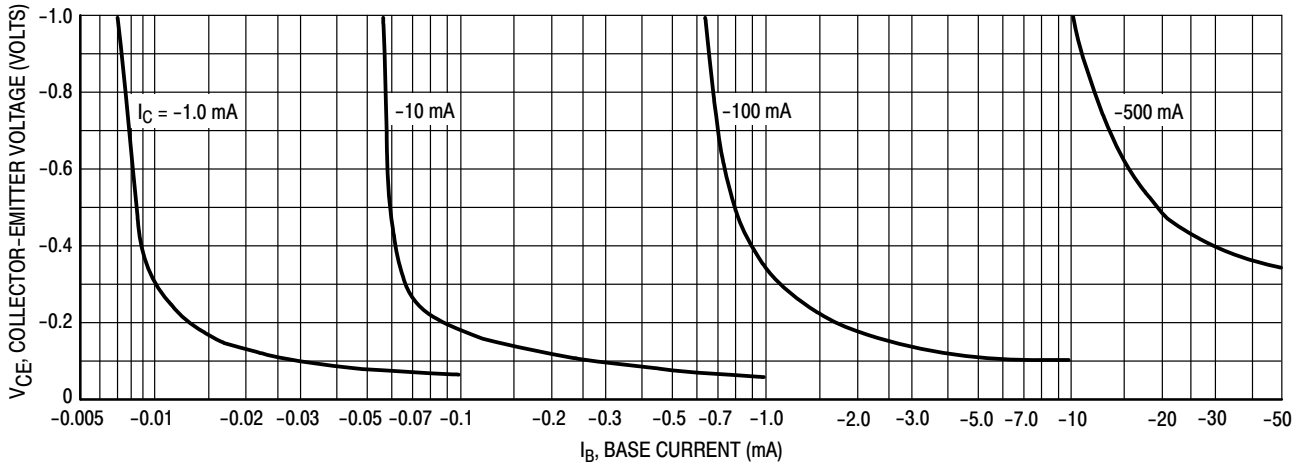


Figure 4. Collector Saturation Region

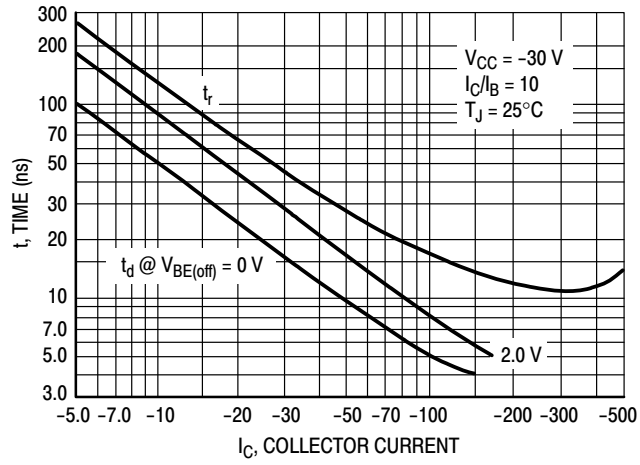


Figure 5. Turn−On Time

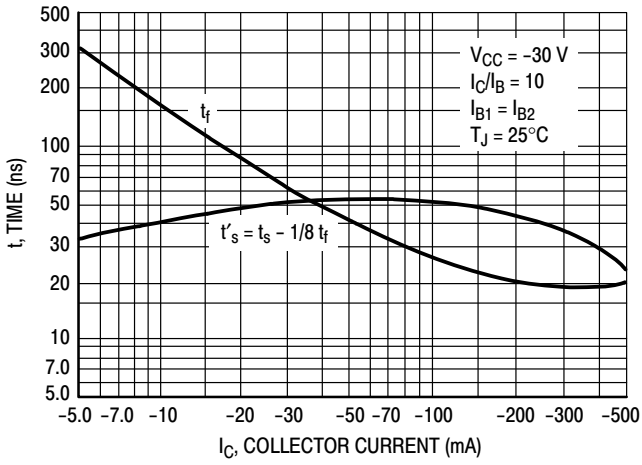


Figure 6. Turn−Off Time

TYPICAL SMALL–SIGNAL CHARACTERISTICS

NOISE FIGURE

V_{CE} = 10 Vdc, T_A = 25°C

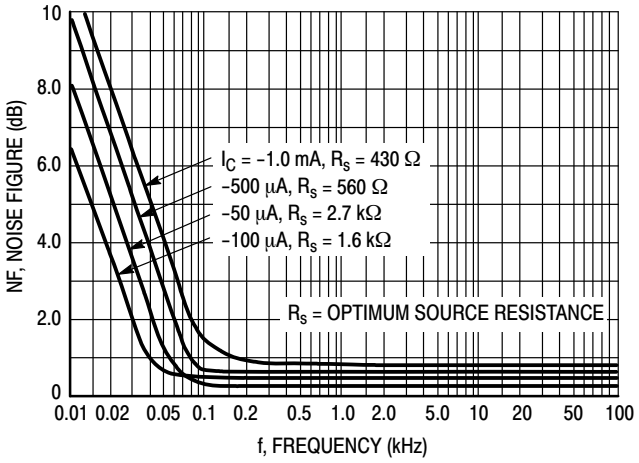


Figure 7. Frequency Effects

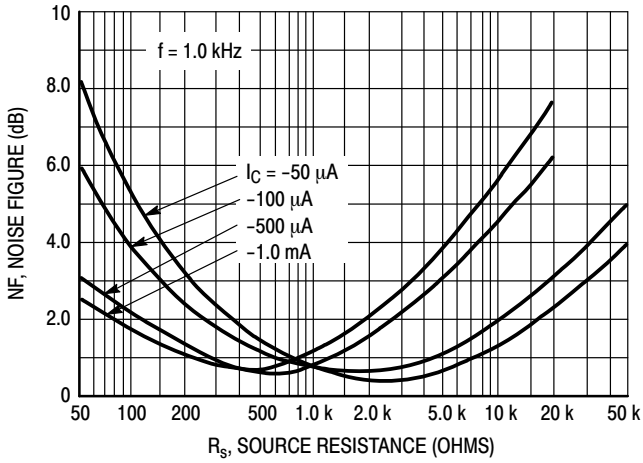


Figure 8. Source Resistance Effects

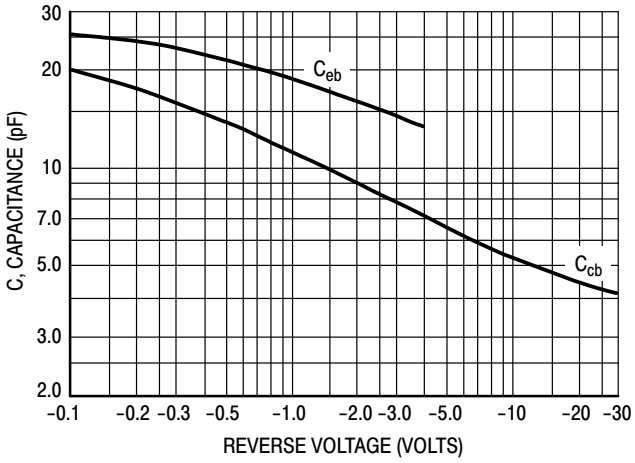


Figure 9. Capacitances

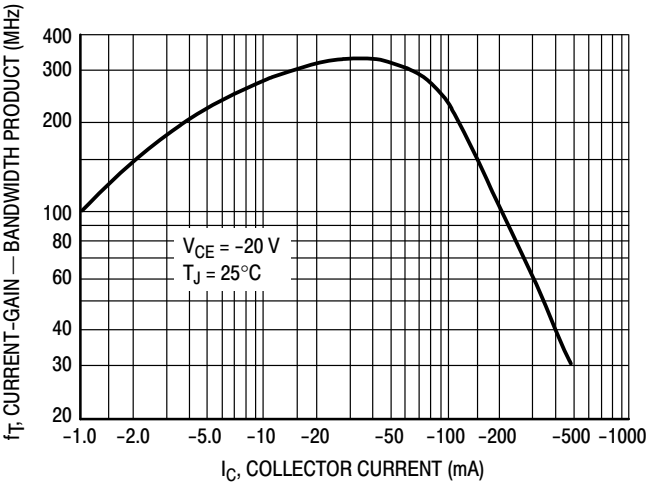


Figure 10. Current–Gain – Bandwidth Product

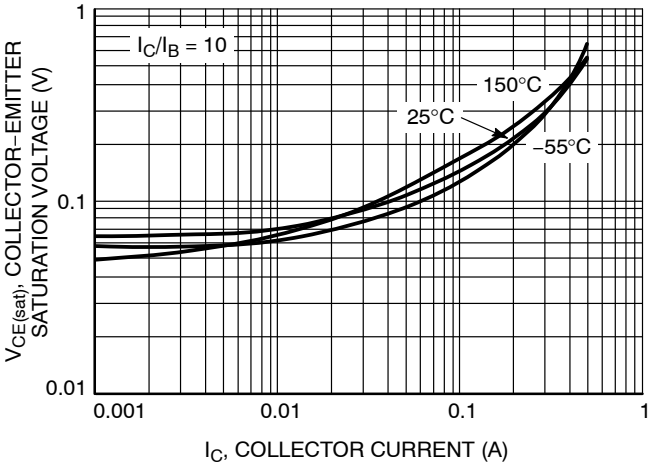


Figure 11. Collector Emitter Saturation Voltage vs. Collector Current

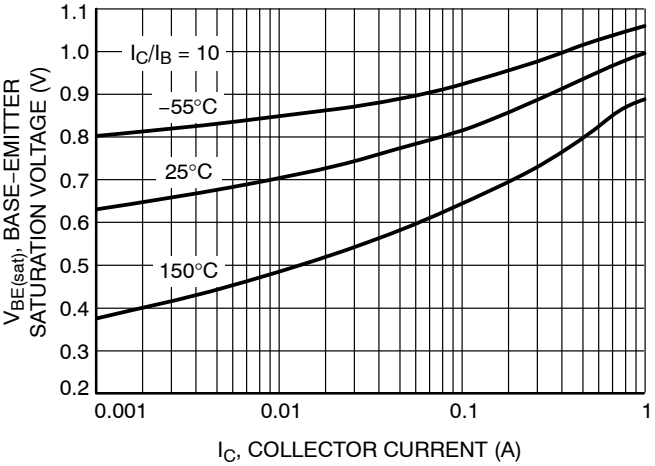


Figure 12. Base Emitter Saturation Voltage vs. Collector Current

TYPICAL SMALL–SIGNAL Characteristics

NOISE FIGURE

V_{CE} = 10 Vdc, T_A = 25°C

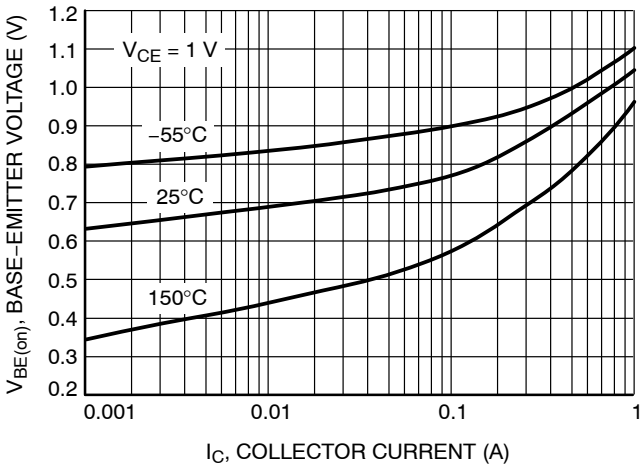


Figure 13. Base Emitter Voltage vs. Collector Current

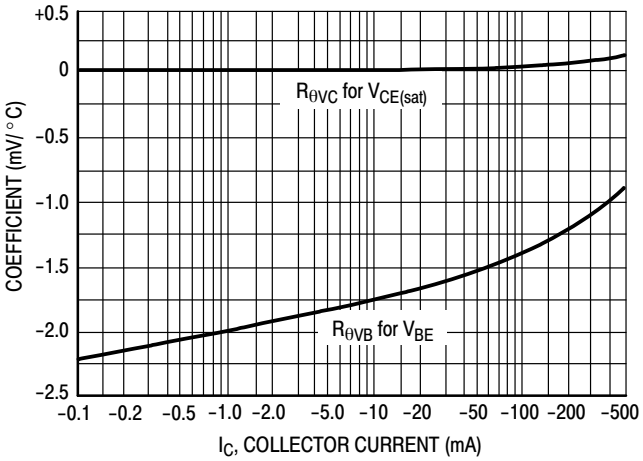


Figure 14. Temperature Coefficients

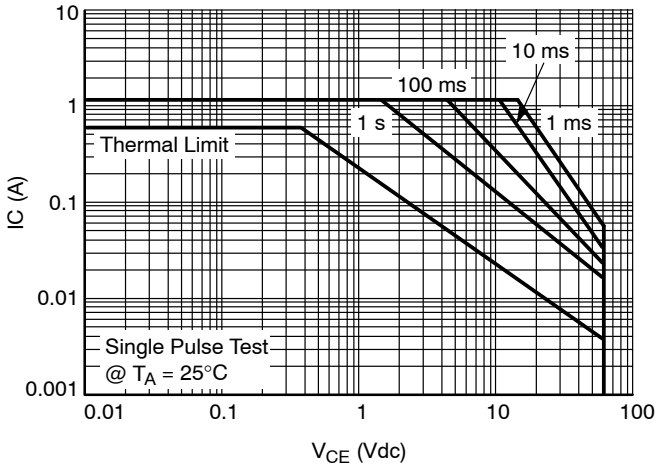
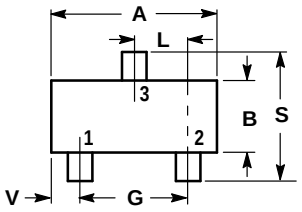
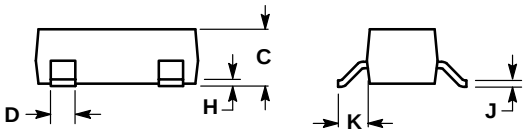


Figure 15. Safe Operating Area

LMBT2907LT1G LMBT2907ALT1G
S-LMBT2907LT1G S-LMBT2907ALT1G

SOT-23





NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

PIN 1. BASE
2. EMITTER
3. COLLECTOR